# **Special Issue**

# Next Generation RFID Transponders

# Message from the Guest Editors

This Special Issue solicits review and original articles that cover next-generation auto-identification systems, especially the transponder. At the physical level, new functional materials are being developed, and transduction mechanisms are studied to improve the coupling efficiency. At the device level, researchers are integrating their transponder's circuitry with MEMS sensors for enhanced capabilities. In order to do so, the energy harvester module is added to supplement the RF power from the interrogator. At the circuit level, we would like to highlight the advances in integrated circuit and antennae for ultrasensitive detection, and fabrication techniques such as printed RFID. Finally, we also welcome articles that address practical issues such as packaging of transponders for niche environments, etc.

### **Guest Editors**

Dr. Faisal Mohd-Yasin

Dr. Khaw Mei Kum

Dr. Ying Khai Teh

## Deadline for manuscript submissions

closed (31 May 2021)



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You are invited to contribute research articles or comprehensive reviews for consideration and publication in *Micromachines* (ISSN 2072-666X). *Micromachines* is published in the open access format. Research articles, reviews and other contents are released on the internet immediately after acceptance. The scientific community and the general public have unlimited free access to the content as soon as it is published. As an open access journal, *Micromachines* is supported by the authors or their institutes by payment of article processing charges (APC) for accepted papers. We are pleased to welcome you as our authors.

#### Editor-in-Chief

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